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ASR6501 Datasheet

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版本历史

版本号	修改日期	作 者	修 改 说 明
V0.1	2018.05.16	ASR6501 Design Team	Created
V0.2	2018.05.22	ASR6501 Design Team	1. Change the package size to 6mm x 6mm x0.9mm 2. Add current in Tx 17dBm output Spec.
V0.3	2018.05.23	ASR6501 Design Team	1. Remove module information. 2. Change the SRAM from 4kBytes to 16kBytes.
V0.4	2018.05.31	ASR6501 Design Team	1. Change 1.2 Block diagram DI0 direction.
V0.5	2018.07.05	ASR6501 Design Team	1. Change XRES pin function description.
V0.6	2018.08.03	ASR6501 Design Team	1. Change RX current from 15mA to 11mA.
V0.7	2018.09.13	ASR6501 Design Team	1. Add deepsleep current without RF Config Retention and without RTC mode current. 2. Update RX mode current to 10mA. 3. Update TX mode current at TX OPT mode results.
V0.8	2018.11.27	ASR6501 Design Team	1. Add some pin usage forbiddens.

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1 General Description

The ASR6501 is a general LoRa Wireless Communication Chipset, with integrated LoRa Radio Transceiver, LoRa Modem and a 32-Bit RISC MCU. The MCU uses ARM Cortex M0+, with 48MHz operation frequency. The LoRa Radio Transceiver has continuous frequency coverage from 150MHz to 960MHz. The LoRa Modem supports LoRa modulation for LPWAN use cases and (G)FSK modulation for legacy use cases. The LoRa Wireless Communication module designed by ASR6501 provides ultra long range, ultra low power communication for LPWAN application.

The ASR6501 can achieve a high sensitivity of over -140dBm and the maximum transmit power is higher than +21dBm. This makes it suitable to be used in long range LPWAN and have high efficiency. The total chip package is of very small size, 6mm x 6mm.

1.1 Key Feature

- ◆ Small footprint: 6mm x 6mm x 0.9mm.
- ◆ LoRa Radio and LoRa Modem.
- ◆ Frequency Range: 150MHz ~ 960MHz.
- ◆ Maximum Power +21dBm constant RF output.
- ◆ High sensitivity: down to -140dBm.
- ◆ Programmable bit rate up to 62.5kbps in LoRa modulation mode.
- ◆ Programmable bit rate up to 300kbps in (G)FSK modulation mode.
- ◆ Preamble detection.
- ◆ Embedded memories (up to 128kbytes of Flash memory and 16Kbytes of SRAM).
- ◆ 6x configurable GPIOs, 1xI2C, 1xUART, 1xSWD.
- ◆ 48-MHz ARM Cortex-M0+ CPU.
- ◆ 8-Channel DMA engine.
- ◆ Embedded 12-bit 1Msps SAR ADC.
- ◆ 32.768kHz External Watch Crystal Oscillator.
- ◆ 4-33MHz External Crystal Oscillator for MCU (Optional).
- ◆ 32MHz External Crystal Oscillator for LoRa Radio.
- ◆ Embedded internal High frequency (48MHz) RC oscillator.
- ◆ Embedded internal Low frequency (40kHz) RC oscillator.
- ◆ Embedded internal PLL to generate 48MHz clock.

1.2 Block Diagram

Fig. 1.1 shows the block diagram of ASR6501 and the ASR LoRa Communication Module.

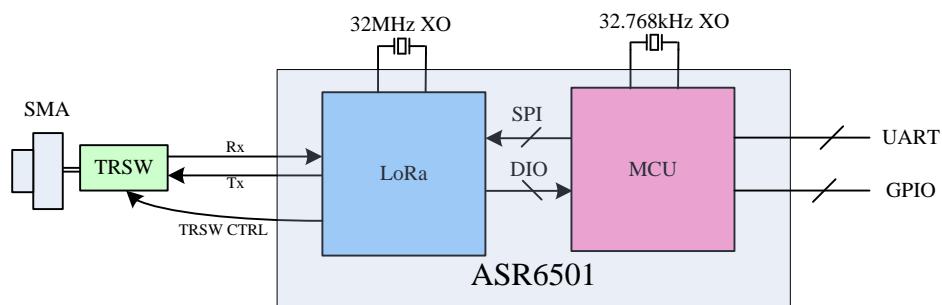


Fig. 1.1: The block diagram of ASR6501 and the ASR LoRa Communication Module

The module of LoRa Communication is designed by ASR6501 and also a reference design for customers. Customers could communicate with ASR6501 by UART and GPIO interfaces.

1.3 General Specification

Following Table 1.1 shows the general specifications of ASR6501 chipset and module.

Table 1.1 General specifications of ASR6501 chipset and module

Chipset Name	ASR6501
Module Name	ASR6501 LoRa Wireless Communication Module
Host Interface	UART, GPIO
Operation Conditions	
Temperature	<ul style="list-style-type: none"> ● Storage: -55C ~ +125C ● Operating: -40C ~ +85C
Humidity	<ul style="list-style-type: none"> ● Storage: 5 ~ 95% (Non-Condensing) ● Operating: 10 ~ 95% (Non-Condensing)
Dimension	6mm x 6mm x 0.9mm
Package	QFN Type

2 Electrical Characteristics

Electrical Characteristics include Absolute Maximum Ratings for the Chipset and Module, Recommended Operating Range and Power Consumption Characteristics. All the data are tested under demo board with fully matching and harmonic filtering networks.

2.1 Absolute Maximum Rating

Symbol	Parameter	Min.	Typ.	Max.	Unit
VDD	Supply Voltage	-0.3		3.9	V
Vin	Digital Input Voltage Level	-0.3		3.9	V
Pin	RF Input Power			+10	dBm

2.2 Power Consumption Characteristics

Symbol	Parameter	Conditions	Typ.	Max.	Unit
IDD_SL	Supply current in Sleep mode	Without RF Config Retention, without RTC	2		uA
		Without RF Config Retention, with RTC	2.7		
		With RF Config Retention and RTC	3.1		uA
IDD_RX	Supply current in Receiver mode		10		mA
IDD_TX	Supply current in Transmitter mode	Pout=+22dBm	108		mA
		Pout=+22dBm(TX OPT)	85		mA
		Pout=+21dBm	106		mA
		Pout=+20dBm	98		mA
		Pout=+17dBm	90		mA

	Pout=+17dBm(TX OPT)	52		mA
	Pout=+14dBm	78		mA
	Pout=+10dBm	59		mA
	Pout=+5dBm	47		mA

2.3 Recommended Operating Range

Symbol	Parameter	Min.	Typ.	Max.	Unit
VDD	Supply Voltage	2.4	3.3	3.7	V
Pin	RF Input Power			+10	dBm

2.4 RF Characteristics

The table 2.1 gives the electrical specifications for the LoRa RF transceiver operating with LoRa modulation. Following conditions apply unless otherwise specified:

- ◆ Supply Voltage = 3.3V.
- ◆ Temperature = 25C.
- ◆ Frequency bands: 470MHz.
- ◆ Bandwidth (BW) = 125kHz.
- ◆ Spreading Factor (SF) = 12.
- ◆ Coding Rate (CR) = 4/6.
- ◆ Package Error Rate (PER) = 1%.
- ◆ CRC on payload enabled.
- ◆ Payload length = 10bytes.
- ◆ Preamble Length = 12 symbols.
- ◆ With matched impedances.

Table 2.1: LoRa RF Transceiver Characteristics

LoRa Transmitter RF Characteristics					
Items	Condition	Min.	Typ.	Max.	Unit
Frequency Range		150	470	960	MHz
Tx Power	RFO Pin	18	20	22	dBm
LoRa Receiver RF Characteristics					
Items	Condition	Min.	Typ.	Max.	Unit
Frequency Range		150	470	960	MHz
Sensitivity	125kHz Bandwidth, SF=7		-126		dBm
	125kHz Bandwidth, SF=10		-135		dBm
	125kHz Bandwidth, SF=12		-140		dBm
2nd order harmonic	Tx Power = 20dBm		-41		dBm

2.5 Digital Characteristics

2.5.1 DC Characteristics

Symbol	Description	Conditions	Min.	Typ.	Max.	Unit

VIH	I/O input high level		0.7xVDD			V
VIL	I/O input low level				0.3xVDD	V
RPU	Weak pull up resistor	Vin=GND	30	45	60	KΩ
RPD	Weak pull down resistor	Vin=VDD	30	45	60	KΩ

2.5.2 RST Characteristics

Fig. 2.1 shows the recommended XRES pin connection. An external RESET button is used to generate reset pulse of the whole chip. The 0.1uF capacitor is to filter out the parasitic reset glitch.

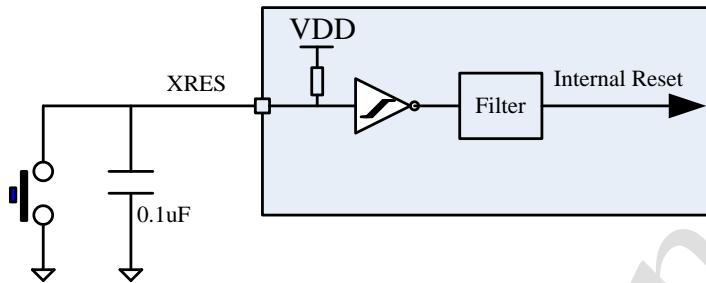


Fig. 2.1: XRES Pin Connection

3 Pin Definition

Pin NO.	Pin Name	P/G/I/O	Description
1	VDD_IN	P	Input voltage for power amplifier, VR_PA
2	ADC_IN	I	ADC input pin.
3	GND	G	Ground
4	XTA	I	XO32M for LoRa input
5	XTB	I	XO32M for LoRa output
6	GPIO	I/O	MCU GPIO
7	AUX	I/O	MCU GPIO
8	SETA	I/O	MCU GPIO
9	DIO3	I/O	Multipurpose digital I/O-external TCXO32M supply voltage, cannot be external GPIO
10	VREG	O	Regulated output voltage from the internal LDO/DC-DC
11	GND	G	Ground
12	DCC_SW	O	DC-DC Switcher Output
13	VBAT_RF	P	Supply for the LoRa Radio
14	UART_RX	I/O	UART RX pin
15	UART_TX	I/O	UART TX pin
16	SWD_DATA	I/O	SWD Data pin
17	SWD_CLK	I/O	SWD Clock pin
18	VDDD	P	Power supply for MCU digital section
19	P4.0	I/O	MCU GPIO for SPI, cannot be external SPI
20	P4.1	I/O	MCU GPIO for SPI, cannot be external SPI
21	P4.2	I/O	MCU GPIO for SPI, cannot be external SPI
22	P4.3	I/O	MCU GPIO for SPI, cannot be external SPI

23	VBAT_DIO	P	Digital I/O supply voltage
24	DIO2	I/O	Multipurpose digital I/O-RF switch control, cannot be external GPIO
25	DIO1	I/O	Multipurpose digital I/O, cannot be external GPIO
26	SPI_BUSY	I/O	SPI busy indicator, cannot be external GPIO
27	SPI_NRESET	I/O	Reset signal, active low, cannot be external GPIO
28	I2C_SCL	I/O	I2C SCL pin
29	I2C_SDA	I/O	I2C SDA pin
30	SETB	I/O	MCU GPIO
31	WCO_IN	I	XO32K for MCU input
32	WCO_OUT	I	XO32K for MCU output
33	UART_CTS	I/O	UART CTS pin
34	UART_RTS	I/O	UART RTS pin
35	SPI_MISO	I/O	SPI slave output, cannot be external SPI
36	SPI_MOSI	I/O	SPI slave input, cannot be external SPI
37	SPI_SCK	I/O	SPI clock, cannot be external SPI
38	XRES	I	External reset pin
39	SPI_NSS	I/O	SPI slave select, cannot be external SPI
40	SCAN	I	LoRa Scan pin
41	VCCD	P	Regulated digital supply ($1.8V \pm 5\%$)
42	VDDD	P	Power supply for MCU digital section
43	VDDA	P	Power supply for MCU analog section
44	VSSA	G	Ground
45	RFI_P	I	RF receiver input
46	RFI_N	I	RF receiver input
47	FRO	O	RF transmitter output
48	VR_PA	O	Regulated power amplifier supply

3.1 Pin Assignment

Fig. 3.1 shows the pin assignment of ASR6501, QFN 6mmx6mm package is used and the total footprint is 48 pins.

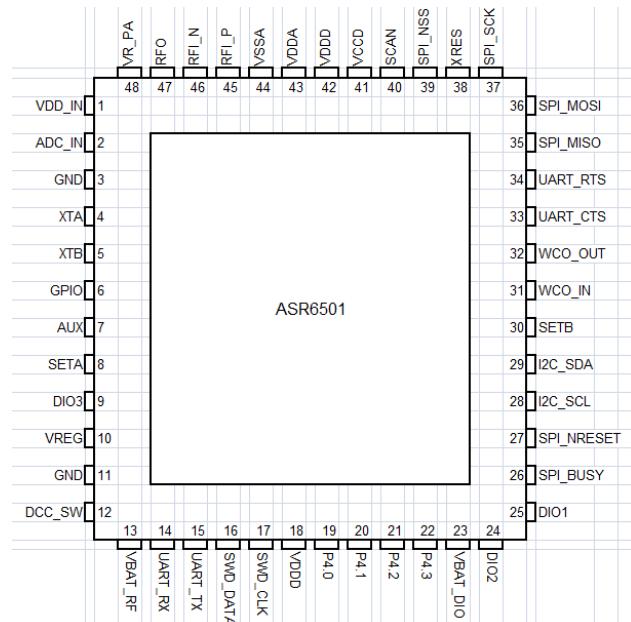
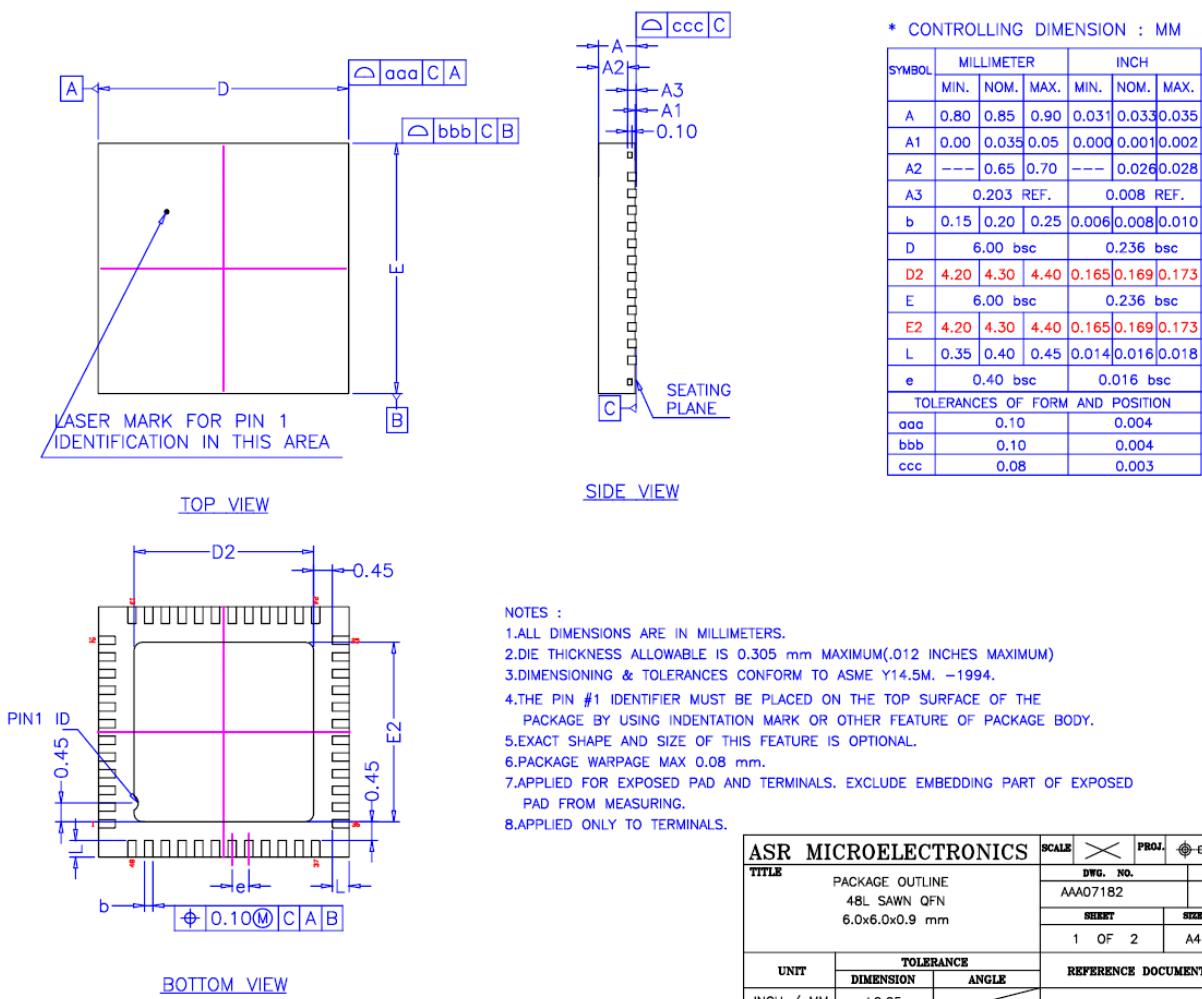


Fig. 3.1 Pin assignment of ASR6501

4 Mechanical Dimension



5 Package Information

5.1 Product Marking

Fig. 5.1 shows the product marking of ASR6501.

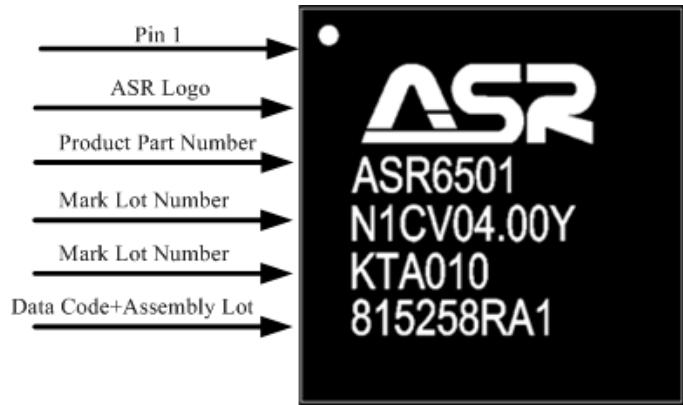


Fig. 5.1 The product marking of ASR6501